



DUAL COMPLEMENTARY PRE-BIASED TRANSISTORS

Features

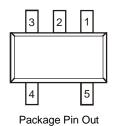
- Ultra-Small Surface Mount Package
- **Epitaxial Planar Die Construction**
- Surface Mount Package Suited for Automated Assembly
- Simplifies Circuit Design and Reduces Board Space
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (UMC4NQ)

Mechanical Data

- Case: SOT353
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.006 grams (Approximate)







Configuration



Device Schematic

Ordering Information (Note 4)

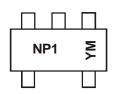
Top View

Part Number	Compliance	Marking	Reel Size (inch)	Tape Width (mm)	Quantity per Reel
UMC4N-7	AEC-Q101	NP1	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



NP1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017)M = Month (ex: 9 = September)

Date Code Key

Year	2017		2018	2019		2020		2021 2022		2023		2024
Code	E		F	G		Н			J	K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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Absolute Maximum Ratings, Pre-Biased NPN Transistor, Q₁ (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	Vcc	50	V
Input Voltage	V _{IN}	-10 to +40	V
Output Current	I _O	30	mA
Collector Current	Ic	100	mA

Absolute Maximum Ratings, Pre-Biased PNP Transistor, Q2 (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	V _{CC}	-50	V
Input Voltage	V _{IN}	-40 to +6	V
Output Current	lo	-100	mA
Collector Current	Ic	-100	mA

Thermal Characteristics (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	150	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Note:

Electrical Characteristics, Pre-Biased NPN Transistor, Q₁ (@T_A = +25°C unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	(Note 6)	V _{I(OFF)}	0.5	_	_	V	$V_{CC} = 5V, I_{O} = 100 \mu A$
input voltage	(Note 7)	V _{I(ON)}	_	_	3	V	$V_O = 0.3V, I_O = 2mA$
Output Voltage		V _{O(ON)}		0.1	0.3	V	$I_0 / I_1 = 10 \text{mA}/0.5 \text{ mA}$
Input Current		l _l	_	_	0.18	mA	$V_I = 5V$
Output Current		I _{O(OFF)}	_	_	0.5	μΑ	$V_{CC} = 50V, V_{I} = 0V$
DC Current Gain		Gı	68	_	_	_	$V_0 = 5V, I_0 = 5mA$
Gain-Bandwidth Product (Note 8)		f⊤	_	250	_	MHz	$V_{CE} = 10V, I_{E} = -5mA, f = 100MHz$
Input Resistance		R ₁	32.9	47	61.1	kΩ	_
Resistance Ratio		R ₂ /R ₁	0.8	1	1.2	_	_

Notes:

- 6. The device is guaranteed to be in "OFF" state with $V_{I(OFF)}$ up to 0.5V.
- 7. The device is guaranteed to be in "ON" state with $V_{I(ON)}$ starting from 3V.
- 8. Characteristic of Transistor for reference only.

Electrical Characteristics, Pre-Biased PNP Transistor, Q2 (@TA = +25°C unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Innut Voltage	(Note 9)	V _{I(OFF)}	-0.3	_	_	V	$V_{CC} = -5V$, $I_{O} = -100\mu A$
Input Voltage	(Note 10)	V _{I(ON)}	_	_	-1.4	V	$V_O = -0.3V$, $I_O = -1mA$
Output Voltage		V _{O(ON)}		-0.1	-0.3	V	$I_0/I_1 = -5\text{mA}/-0.25 \text{ mA}$
Input Current		lı	_	_	-0.88	mA	$V_I = -5V$
Output Current		I _{O(OFF)}	_	_	-0.5	μΑ	$V_{CC} = -50V$, $V_I = 0V$
DC Current Gain		Gı	68	_	_	_	$V_{O} = -5V, I_{O} = -5mA$
Gain-Bandwidth Product (Note 11)		f⊤	_	250	_	MHz	$V_{CE} = -10V$, $I_{E} = 5mA$, $f = 100MHz$
Input Resistance		R ₁	7	10	13	kΩ	_
Resistance Ratio		R ₂ /R ₁	3.7	4.7	5.7	_	_

Notes:

- 9. The device is guaranteed to be in "OFF" state with $V_{\text{I(OFF)}}$ up to -0.3V.
- 10. The device is guaranteed to be in "ON" state with $V_{I(ON)}$ starting from -1.4V.
- 11. Characteristic of Transistor for reference only.

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^{5.} For the device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.



Typical Electrical Characteristics (@TA = +25°C unless otherwise specified.)

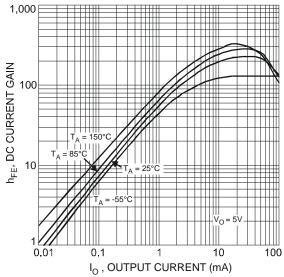
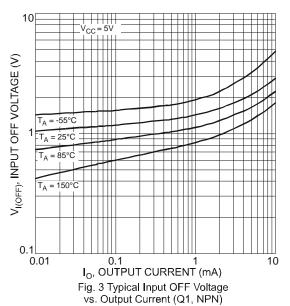


Fig. 1 Typical DC Current Gain vs. Output Current (Q1, NPN)



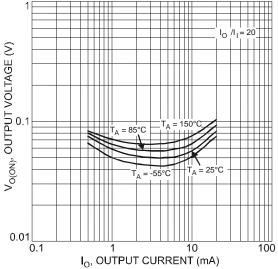
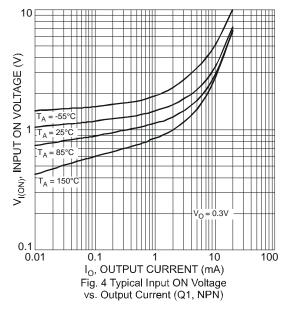
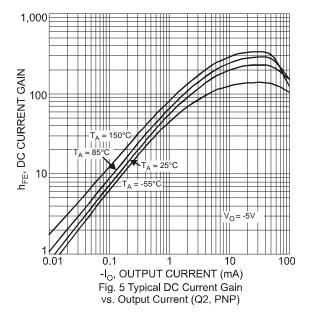


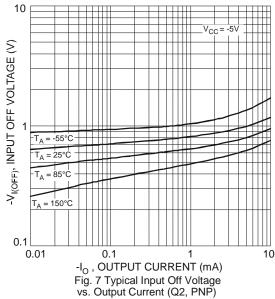
Fig. 2 Typical Output Voltage vs. Output Current (Q1, NPN)

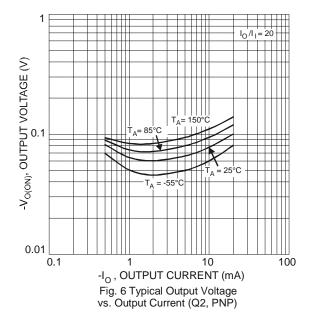


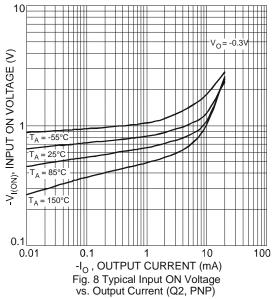


Typical Electrical Characteristics (Cont.) (@TA = +25°C unless otherwise specified.)







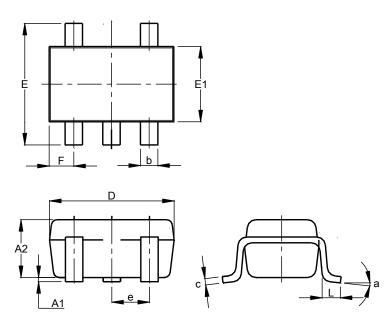




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT353

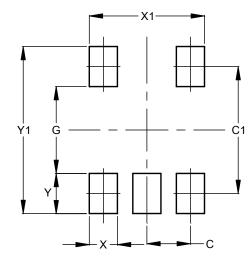


	SOT353							
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	1.00					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C).650 B	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT353



Dimensions	Value
Dimensions	(in mm)
С	0.650
C1	1.900
G	1.300
Х	0.420
X1	1.720
Υ	0.600
V1	2 500



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